

# MITSUBISHI RF POWER TRANSISTOR 2SC1729

## NPN EPITAXIAL PLANAR TYPE

### DESCRIPTION

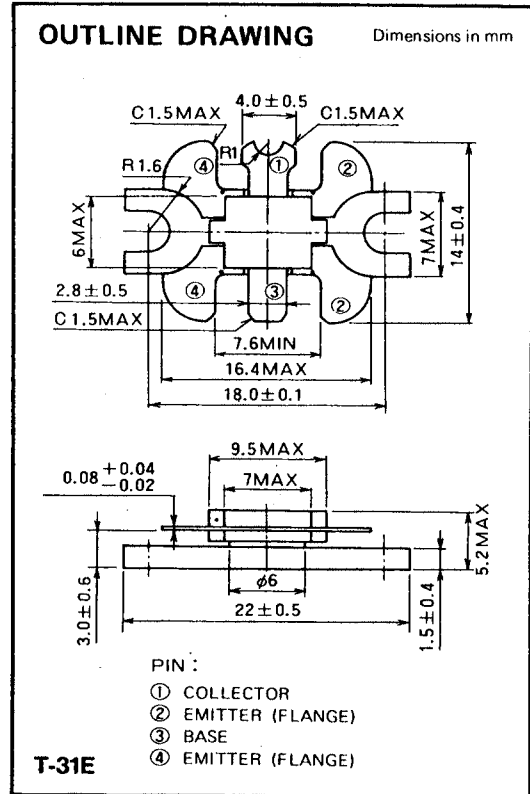
2SC1729 is a silicon NPN epitaxial planar type transistor designed for RF power amplifiers on VHF band mobile radio applications.

### FEATURES

- High power gain:  $G_{pe} \geq 10\text{dB}$   
@  $V_{CC} = 13.5\text{V}$ ,  $P_o = 14\text{W}$ ,  $f = 175\text{MHz}$
- Emitter ballasted construction and gold metallization for high reliability and good performances.
- Low thermal resistance ceramic package with flange.
- Ability of withstanding more than 20:1 and load VSWR when operated at  $V_{CC} = 15.2\text{V}$ ,  $P_o = 18\text{W}$ ,  $f = 175\text{MHz}$ .
- Equivalent input/output series impedance:  
 $Z_{in} = 2.3 + j1.1 \Omega$  @  $P_o = 14\text{W}$ ,  $V_{CC} = 13.5\text{V}$ ,  $f = 175\text{MHz}$   
 $Z_{out} = 3.1 - j2.2 \Omega$

### APPLICATION

10 to 14 watts output power amplifiers applications in VHF band.



### ABSOLUTE MAXIMUM RATINGS ( $T_C = 25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Conditions	Ratings	Unit
$V_{CBO}$	Collector to base voltage		35	V
$V_{EBO}$	Emitter to base voltage		4	V
$V_{CEO}$	Collector to emitter voltage	$R_{BE} = \infty$	17	V
$I_C$	Collector current		3.5	A
$P_C$	Collector dissipation	$T_a = 25^\circ\text{C}$	2.5	W
		$T_C = 25^\circ\text{C}$	35	W
$T_j$	Junction temperature		175	$^\circ\text{C}$
$T_{stg}$	Storage temperature		-65 to 175	$^\circ\text{C}$
$R_{th-a}$	Thermal resistance	Junction to ambient	60	$^\circ\text{C}/\text{W}$
$R_{th-c}$		Junction to case	4.3	$^\circ\text{C}/\text{W}$

Note. Above parameters are guaranteed independently.

### ELECTRICAL CHARACTERISTICS ( $T_C = 25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Test conditions	Limits			Unit
			Min	Typ	Max	
$V_{(BR)EBO}$	Emitter to base breakdown voltage	$I_E = 10\text{mA}$ , $I_C = 0$	4			V
$V_{(BR)CBO}$	Collector to base breakdown voltage	$I_C = 10\text{mA}$ , $I_E = 0$	35			V
$V_{(BR)CEO}$	Collector to emitter breakdown voltage	$I_C = 50\text{mA}$ , $R_{BE} = \infty$	17			V
$I_{CBO}$	Collector cutoff current	$V_{CB} = 25\text{V}$ , $I_E = 0$			1	mA
$I_{EBO}$	Emitter cutoff current	$V_{EB} = 3\text{V}$ , $I_C = 0$			0.5	mA
$h_{FE}$	DC forward current gain *	$V_{CE} = 10\text{V}$ , $I_C = 0.1\text{A}$	10	50	180	—
$P_o$	Output power	$V_{CC} = 13.5\text{V}$ , $P_{in} = 1.4\text{W}$ , $f = 175\text{MHz}$	14	16		W
$\eta_C$	Collector efficiency		60	70		%

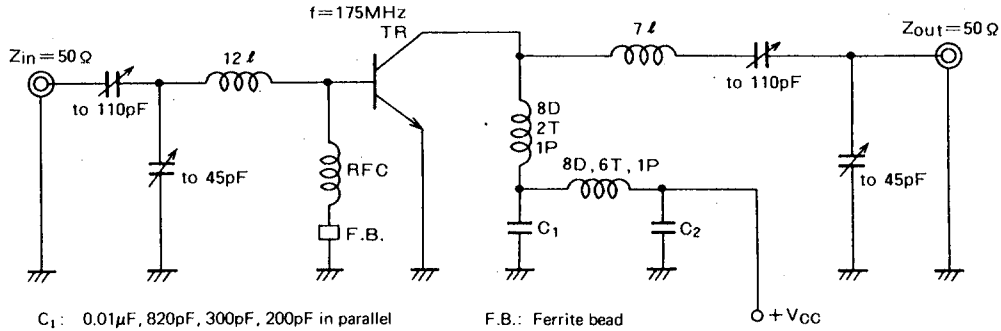
Note. \* Pulse test,  $P_W = 150\mu\text{s}$ , duty=5%.

Above parameters, ratings, limits and conditions are subject to change.

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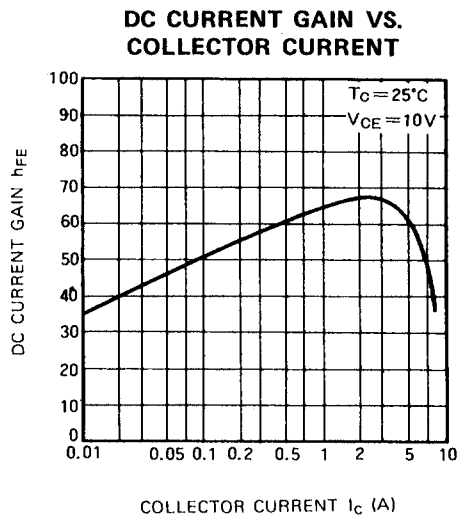
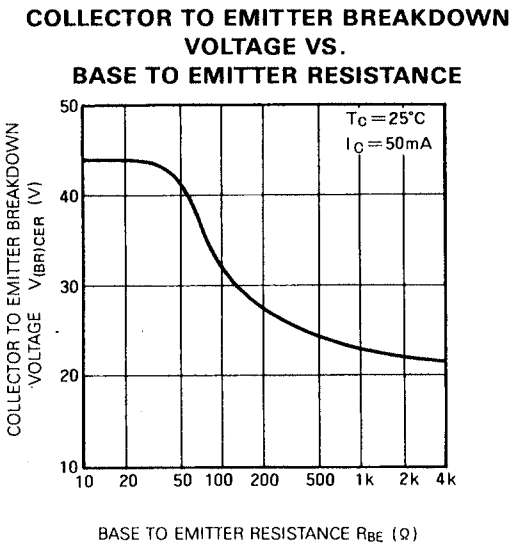
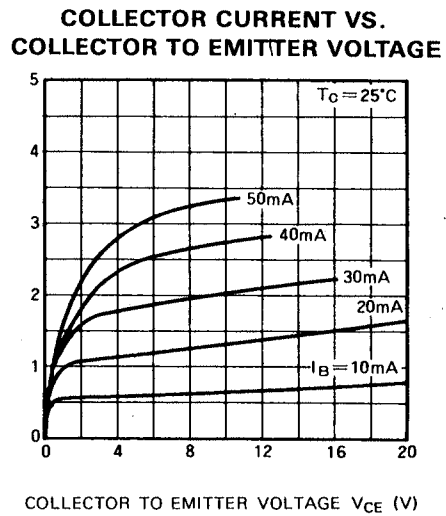
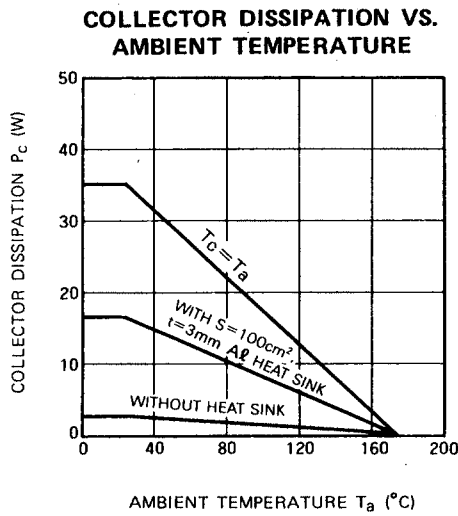
**NPN EPITAXIAL PLANAR TYPE**

**TEST CIRCUIT**

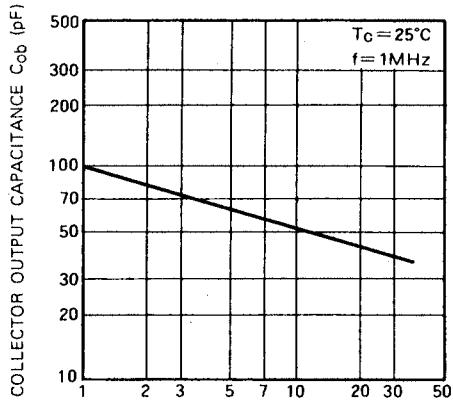


$C_1$ : 0.01 $\mu$ F, 820pF, 300pF, 200pF in parallel  
 $C_2$ : 22 $\mu$ F, 0.1 $\mu$ F, 0.02 $\mu$ F, 300pF in parallel  
 Notes: All coils are made from 1.5mm $\phi$  silver plated copper wire  
 Coil dimensions in milli-meter  
 D: Inner diameter of coil  
 T: Turn number of coil  
 P: Pitch of coil  
 $\ell$ : Length

**TYPICAL PERFORMANCE DATA**

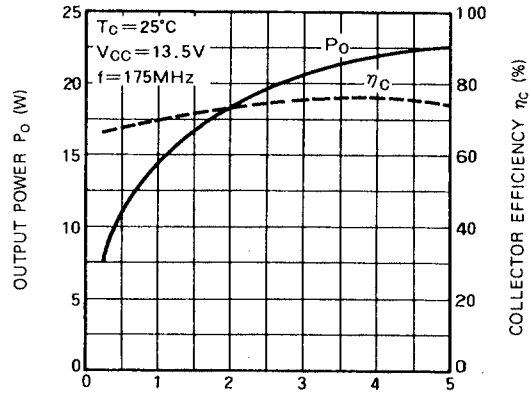


**COLLECTOR OUTPUT CAPACITANCE VS. COLLECTOR TO BASE VOLTAGE**



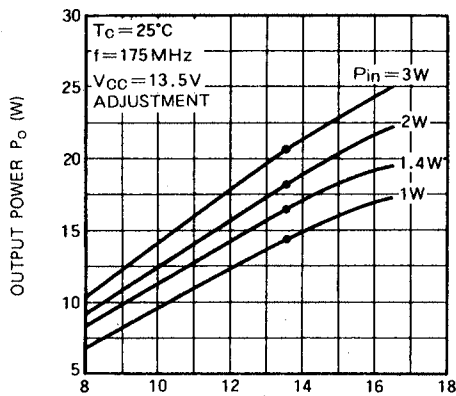
COLLECTOR TO BASE VOLTAGE  $V_{CB}$  (V)

**OUTPUT POWER, COLLECTOR EFFICIENCY VS. INPUT POWER**



INPUT POWER  $P_{in}$  (W)

**OUTPUT POWER VS. COLLECTOR SUPPLY VOLTAGE**



COLLECTOR SUPPLY VOLTAGE  $V_{CC}$  (V)